

DATA SHEET

FUSIBLE CHIP RESISTORS FR series (Pb Free) 5%

sizes 0603/1206



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SCOPE

This specification describes FR0603/1206 fusible chip resistors with leadfree terminations made by thick film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

PHYCOMP ORDERING CODE

12NC CODE

2322		XXX	<u>XX</u> XXX L		
	(1))	(2)	(3) (4)	
SIZE	TYPE	start IN ⁽¹⁾	TOL. (%)	RESISTANCE RANGE	PAPER/PE TAPE ON REEL (units) (2) 5,000
0603	FRC21	2322	±5%	l to 240 Ω	756 60xxx
1206	FRC01	2322	±5%	to 510 Ω	750 6xxxx

- (1) The resistors have a 12-digit ordering code starting with 2322.
- (2) The subsequent 4 or 5 digits indicate the resistor tolerance and packaging.
- (3) The remaining 4 or 3 digits represent the resistance value with the last digit indicating the multiplier as shown in the table of "Last digit of I2NC".
- (4) "L" means lead-free terminations ^(a).

ORDERING EXAMPLE

The ordering code of a FRC01 resistor, value 200 Ω with ±5% tolerance, supplied in tape of 5,000 units per reel is: 232275062001L.

Last digit of 12NC						
Resistance decade ⁽³⁾ Last digit						
0.01 to 0.0	976 Ω		0			
0.1 to 0.97	'6 Ω		7			
l to 9.76 Ω						
10 to 97.6	Ω		9			
100 to 976	Ω		1			
l to 9.76 k	Ω		2			
10 to 97.6	kΩ		3			
100 to 976	kΩ		4			
l to 9.76 N	ſΩ		5			
10 to 97.6	MΩ		6			
Example:	0.02 Ω	=	0200 or 200			
	0.3 Ω	=	3007 or 307			
	ΙΩ	=	1008 or 108			
	33 kΩ	=	3303 or 333			
	10 MΩ	=	1006 or 106			

APPLICATIONS

- Power supply in small equipment
- Car telephones
- Portable radio, CD and cassette players

CTC CODE

FR XXXX X X X XX XXXX L

(1) (2) (3) (4) (5) (6) (7)

(I) SIZE

0603/1206

(2) TOLERANCE

 $] = \pm 5\%$

(3) PACKAGING TYPE

R = Paper/PE taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(5) TAPING REEL

07 = 7 inch dia. Reel

(6) RESISTANCE VALUE

IR, 5R6, 56R, 510R.

(7) RESISTOR TERMINATIONS (a)

L = Lead-free terminations (matte tin)

ORDERING EXAMPLE

The ordering code of a FRI206 chip resistor, value 200 Ω with ±5% tolerance, supplied in 7-inch tape reel is: FR1206JR-07200RL.

NOTE

- The "L" at the end of the code is only for ordering. On the reel label, the standard CTC or I2NC will be mentioned an additional stamp a. "LFP"= lead free production.
- b. Products with lead in terminations fulfil the same requirements as mentioned in this datasheet.
- c. Products with lead in terminations will be phased out in the coming months (before July 1st, 2006)

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<u>MARKING</u>

FR0603/1206



E-24 series: 3 digits

First two digits for significant figure and 3rd digit for number of zeros

For marking codes, please see EIA-marking code rules in data sheet "Chip resistors marking".

CONSTRUCTION

The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive paste. The composition of the paste is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with an overcoat and printed with the resistance value. Finally, the two external terminations (matte tin) are added.

To enable recognition of a fusible device, the resistor should be mounted face up. See fig. 2.

DIMENSIONS

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TYPE	L (mm)	W (mm)	H (mm)	l⊤(mm)	l₂ (mm)
FR0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.25 ±0.15	0.25 ±0.15
FR1206	3.10 ±0.10	1.60 ±0.10	0.55 ±0.10	0.45 ±0.20	0.40 ±0.20

OUTLINES



ELECTRICAL CHARACTERISTICS

Table 2

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TYPE	RESISTANCE RANGE	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	Temperature Coefficient of Resistance
FR0603	±5% (E-24), ∣Ω≤R≤240Ω	–55 °C	50 V	100 V	100 V	$ \Omega \le R \le 0 \Omega: 0 +500 \text{ ppm/°C}$ $ 0 \Omega < R \le 240 \Omega: \pm 200 \text{ ppm/°C}$
FR1206	±5% (E-24), ∣Ω≤R≤510Ω	to - +125 °C	200 V	500 V	500 V	I Ω ≤ R < 5 Ω: ±250 ppm/°C 5 Ω ≤ R ≤ 510 Ω: ±200 ppm/°C

Chip Resistor Surface MountFRSERIES0603/1206 (Pb Free)

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

ENVIRONMENTAL DATA

For material declaration information (IMDS-data) of the products, please see the separated info "Environmental data" conformed to EU RoHS.

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

		FR0603	FR1206
Paper/PE taping reel (R)	7" (178 mm)	5,000	5,000

NOTE

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1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet "Packing" document.

FUNCTIONAL DESCRIPTION

PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of $\pm 5\%$. The values of the E24 series are in accordance with "IEC publication 60063".

FUSING CHARACTERISTICS

The resistors will fuse without the risk of fire and within an indicated range of overload. Fusing means that the resistive value of the resistor increases at least 100 times; see Figs 3 and 4.

The fusing characteristic is measured under constant voltage with resistors mounted on a ceramic or glass epoxy (FR4) substrate; see Fig. 5.





 Chip Resistor Surface Mount
 FR
 SERIES
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OPERATING TEMPERATURE RANGE

Range: -55°C to +125°C

LIMITING VALUES

Table 4

TYPE	LIMITING VOLTAGE ⁽¹⁾	LIMITING POWER ⁽³⁾
	(V)	(W)
FR0603	50 (2)	1/16
FR1206	200 (2)	1/8

NOTES

- 1. The maximum voltage that may be continuously applied to the resistor element, see "IEC publication 60115-8".
- 2. The maximum voltage that may be applied after fusing is shown in Fig. 6.
- 3. Each type rated power at 70°C.



Product specification

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POWER RATING

The power that the resistor can dissipate depends on the operating temperature; see Fig. 7.

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

 $V = \sqrt{(P \times R)}$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$



PULSE LOADING CAPABILITIES





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TESTS AND REQUIREMENTS

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature	MIL-STD-202F-method 304;	At +25/–55 °C and +25/+125 °C	Refer to table 2
Coefficient of Resistance	JIS C 5202-4.8	Formula:	
(T.C.R.)		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where t ₁ =+25 °C or specified room temperature	
		t ₂ =–55 °C or +125 °C test temperature	
		R ₁ =resistance at reference temperature in ohms	
		R_2 =resistance at test temperature in ohms	
Thermal Shock	MIL-STD-202F-method 107G;	At -65 (+0/-10) °C for 2 minutes and at +125	±(1.0%+0.05 Ω)
	IEC 60115-1 4.19	(+10/–0) °C for 2 minutes; 25 cycles	
Low	MIL-R-55342D-Para 4.7.4	At –65 (+0/–5) °C for I hour, RCWV applied	±(1.0%+0.05 Ω)
Temperature		for 45 (+5/–0) minutes	No visible damage
Operation			
Short Time	MIL-R-55342D-Para 4.7.5;	2.5 × RCWV applied for 5 seconds at room	±(1.0%+0.05 Ω)
Overload	IEC 60115-1 4.13	temperature	No visible damage
Insulation	MIL-STD-202F-method 302;	One DC voltage (V) applied for 1 minute	≥10 GΩ
Resistance	IEC 60115-1 4.6.1.1	Details see below table 6	
Dielectric	MIL-STD-202F-method 301;	One AC voltage (V _{rms}) applied for 1 minute	No breakdown or flashover
Withstand Voltage	IEC 60115-1 4.6.1.1	Details see below table 6	
Resistance to	MIL-STD-202F-method 210C;	Unmounted chips; 260 \pm 5 °C for 10 \pm 1	±(1.0%+0.05 Ω)
Soldering Heat	IEC 60115-1 4.18	seconds	No visible damage
Life	MIL-STD-202F-method 108A;	At 70±2 °C for 1,000 hours; RCWV applied for	±(3%+0.05 Ω)
	IEC 60115-1 4.25.1	1.5 hours on and 0.5 hour off	
Solderability	MIL-STD-202F-method 208A;	Solder bath at 245±3 °C	Well tinned (≥95% covered)
	IEC 60115-1 4.17	Dipping time: 2±0.5 seconds	No visible damage
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Table 5	Test condition, p	procedure and	requirements ((continued)

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS	
Bending	JIS C 5202.6.14;	Resistors mounted on a 90 mm glass epoxy	±(1.0%+0.05 Ω)	
Strength	IEC 60115-1 4.15	resin PCB (FR4)	No visible damage	
		Bending: 5 mm		
Resistance to	MIL-STD-202F-method 215;	lsopropylalcohol (C ₃ H ₇ OH) or dichloromethane	No smeared	
Solvent	IEC 60115-1 4.29	(CH_2Cl_2) followed by brushing		
Noise	JIS C 5202 5.9;	Maximum voltage (V _{ms}) applied	Resistors range	Value
	IEC 60115-1 4.12		R < 100 Ω	10 dB
			$100 \ \Omega \le R < K\Omega$	20 dB
			$ K\Omega \le R < 0 K\Omega$	30 dB
			$10 \text{ K}\Omega \leq \text{R} < 100 \text{ K}\Omega$	40 dB
			$100 \text{ K}\Omega \leq \text{R} < 1 \text{ M}\Omega$	46 dB
			$ M\Omega \le R \le 22 M\Omega$	48 dB
Humidity	JIS C 5202 7.5;	I,000 hours; 40±2 °C; 93(+2/–3)% RH	+(20%+005 0)	
(steady state)	IEC 60115-8 4.24.8	RCWV applied for 1.5 hours on and 0.5 hour off	±(2.0%±0.03 2 2)	
Leaching	EIA/IS 4.13B;	Solder bath at 260±5 °C	No visible damage	
	IEC 60115-8 4.18	Dipping time: 30±1 seconds		
Intermittent Overload	JIS C 5202 5.8	At room temperature; 2.5 × RCWV applied for I second on and 25 seconds off; total 10,000 cycles	±(2.0%+0.05 Ω)	
Resistance to Vibration	On request	On request		
Moisture	MIL-STD-202F-method 106F;	42 cycles; total 1,000 hours	±(2.0%+0.05Ω)	
Resistance Heat	IEC 60115-1 4.24.2	Shown as Fig. 11	No visible damage	

Table 6 Criteria of rated continued working voltage and overload voltage

ТҮРЕ	FR0603	FR1206
Voltage (DC/unit: V); (AC/ unit: V _{rms})	100	500



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<u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Sep 26, 2005	-	- Unified writing style of content are:
			- New datasheet for fusible chip resistors sizes of 0603/1206 5% with lead-free terminations
			- Replace the 0603/1206 parts of pdf files: FRC21_5_3.pdf, FRC01_5_10.pdf, and combine into a document.
			- Test method and procedure updated
			- PE tape added (paper tape will be replaced by PE tape)

